

1. Scope
- The present specifications shall apply to an FMN-2206S

2. Outline

Type	Silicon Diode
Structure	Resin Molded Flammability : UL94V-0 (Equivalent)
Applications	High Frequency Rectification

3. Absolute maximum ratings

No.	Item	Symbol	Unit	Rating	Conditions
1	Transient Peak Reverse Voltage	V_{RSM}	V	600	
2	Peak Reverse Voltage	V_{RM}	V	600	
3	Average Forward Current	$I_{F(AV)}$	A	20	Refer to Derating of 6
4	Peak Surge Forward Current	I_{FSM}	A	150	10msec. Half sinewave, one shot
5	I^2t Limiting Value	I^2t	A^2s	112.5	$1ms \leq t \leq 10ms$
6	Junction Temperature	T_j	$^{\circ}C$	-40~+150	
7	Storage Temperature	T_{stg}	$^{\circ}C$	-40~+150	

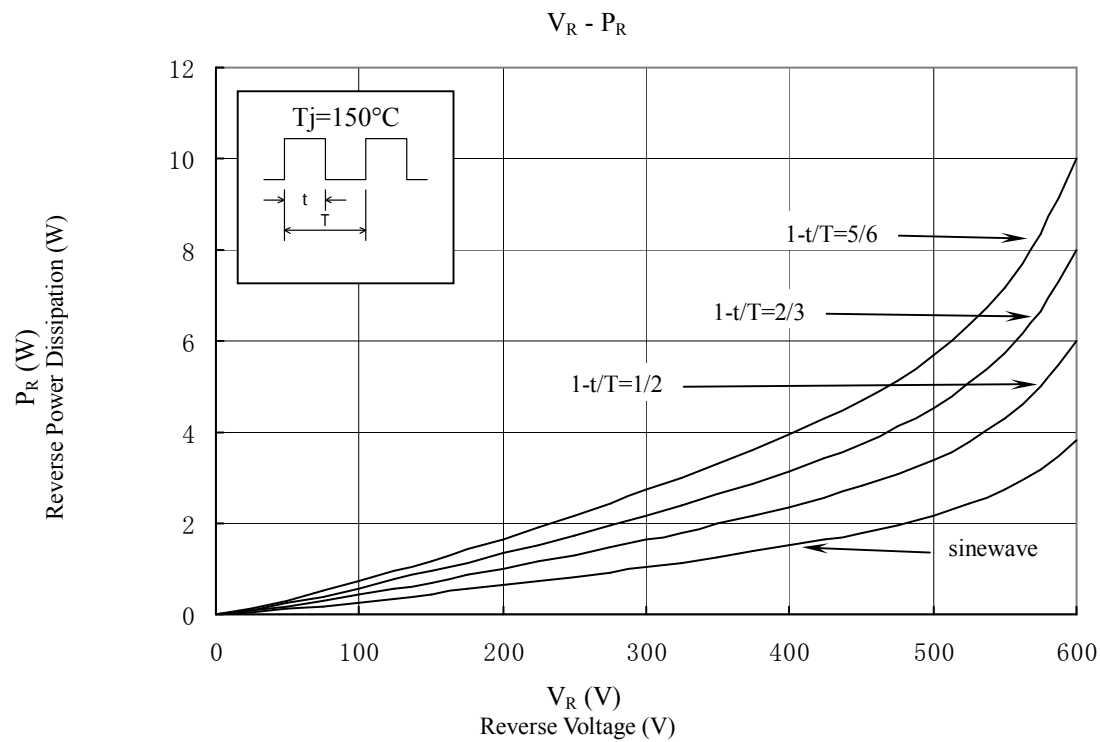
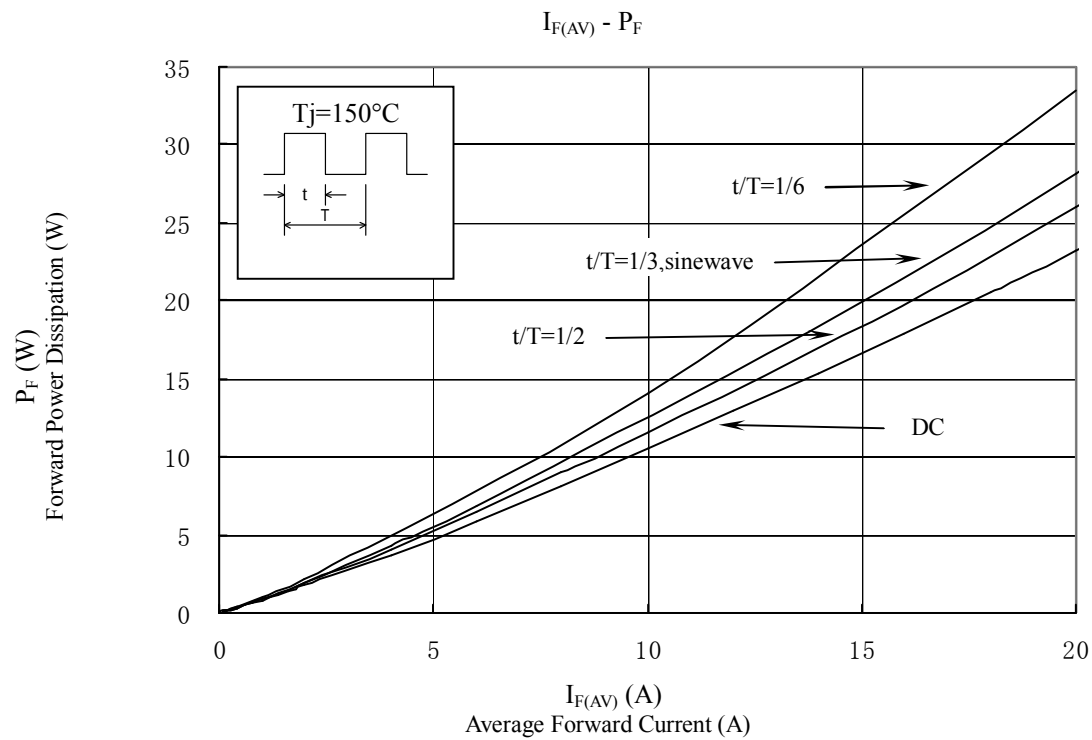
No.1,2,4&5 show ratings per one chip.

4. Electrical characteristics (Ta=25°C, unless otherwise specified)

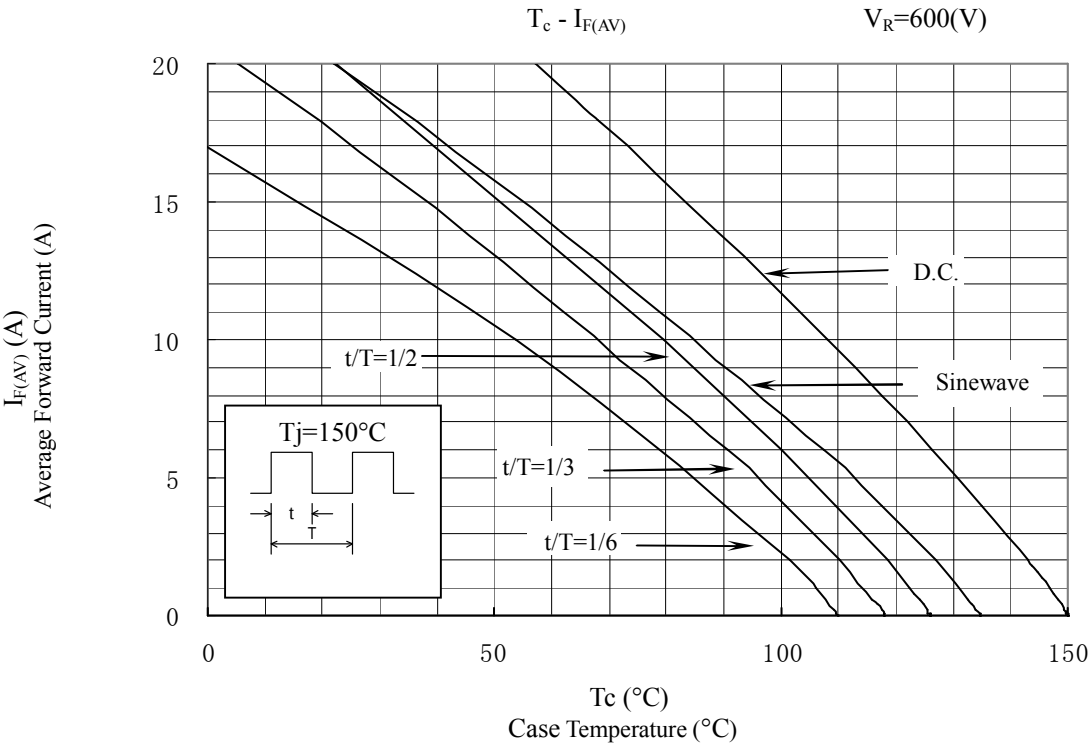
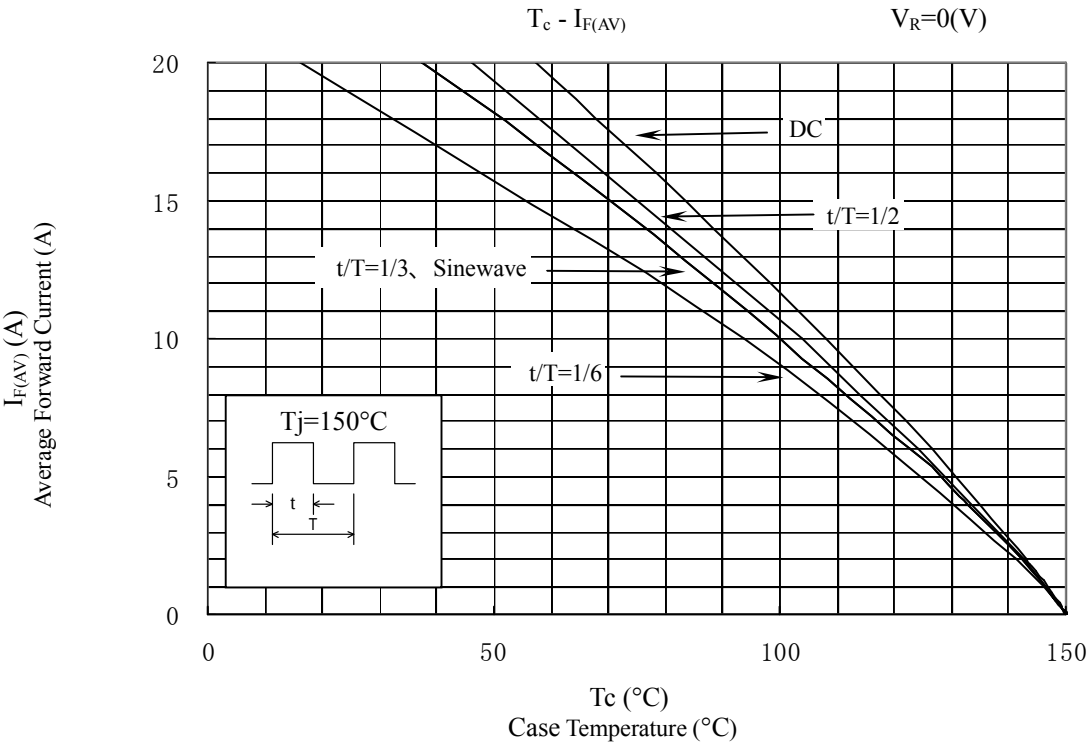
No	Item	Symbol	Unit	Value	Conditions
1	Forward Voltage Drop	V_F	V	1.3 max.	$I_F = 10A$
2	Reverse Leakage Current	I_R	μA	100 max.	$V_R = V_{RM}$
3	Reverse Leakage Current Under High Temperature	$H \cdot I_R$	mA	10 max.	$V_R = V_{RM}$, $T_j = 150^{\circ}C$
4	Reverse Recovery Time	trr1	ns	100 max.	$I_F = I_R = 100mA$ 90% Recovery point, $T_j = 25^{\circ}C$
		trr2	ns	50 max.	$I_F = 100mA$, $I_R = 200mA$, 75% Recovery point, $T_j = 25^{\circ}C$
5	Thermal Resistance	$R_{th(j-c)}$	$^{\circ}C/W$	4.0 max.	Between Junction and case

No.1,2,3&4 show ratings per one chip.

5. Characteristics

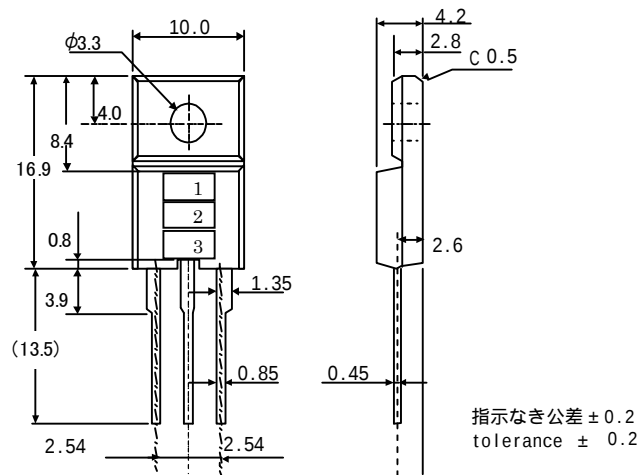


6. Derating



7. Package information

7-1Package type, physical dimensions and material



Dimensions in mm

7-2Appearance

The body shall be clean and shall not bear any stain, rust or flaw.

7-3Marking

Type Name	Marking		
	*1 Type Name	*2 Polarity	*3 Lot number
FMN-2206S	N2206		1st letter: Last digit of year 2nd letter: Month From 1 to 9 for Jan. to Sep., O for Oct., N for Nov., D for Dec. 3rd & 4th letter: Day ex. 5729 (July,29, 2005)